

STPS3045DJF

Power Schottky rectifier

Features

- Low forward voltage drop
- Very small conduction losses
- Negligible switching losses
- Extremely fast switching
- Low thermal resistance
- Avalanche capability specified
- Thin package: 1 mm
- ECOPACK[®]2 compliant component

Description

Schottky rectifier suited for switch mode power supply and high frequency DC to DC converters.

Packaged in PowerFLATTM, this device is intended for use in low voltage, high frequency inverters, free-wheeling and polarity protection applications.

Its low profile was especially designed to be used in applications with space-saving constraints.

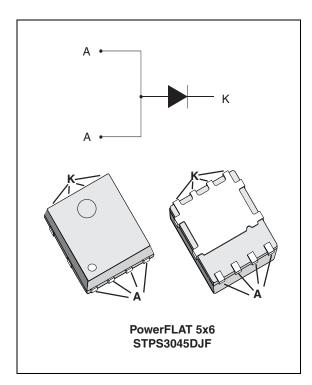


Table 1. Device summary

Symbol	Value
I _{F(AV)}	30 A
V _{RRM}	45 V
T _j (max)	150 °C
V _F (typ)	0.41 V

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1 **Characteristics**

Table 2. Absolute ratings (limiting values, anode terminals short circuited)

Symbol	Parameter	Value	Unit	
V_{RRM}	Repetitive peak reverse voltage	45	V	
I _{F(RMS)}	Forward rms current	45	Α	
I _{F(AV)}	Average forward current $T_c = 95 ^{\circ}\text{C}, \delta = 0.5$		30	Α
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal} $ $T_c = 25 \text{ °C}$		200	Α
P _{ARM}	Repetitive peak avalanche power $t_p = 1 \mu s$ $T_j = 25 °C$		12500	W
T _{stg}	Storage temperature range		-65 to + 175	°C
T _j	Maximum operating junction temperatu	150	°C	

^{1.} $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	2.5	°C/W

Table 4. Static electrical characteristics (anode terminals short circuited)

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
ı (1)	I _R ⁽¹⁾ Reverse leakage current	T _j = 25 °C	$V_R = V_{RRM}$	-	•	300	μΑ
'R`		T _j = 125 °C		-	20	80	mA
	V _F ⁽¹⁾ Forward voltage drop	T _j = 25 °C	I _F = 15 A	-	-	0.56	
V_(1)		T _j = 125 °C		-	0.41	0.46	V
VE. 7 FOI		T _j = 25 °C	I _F = 30 A	-	-	0.64	\ \ \
		T _j = 125 °C		-	0.50	0.56	

^{1.} Pulse test: $t_p = 380 \mu s$, $\delta < 2\%$

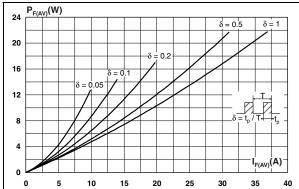
To evaluate the conduction losses use the following equation: P = 0.43 x $I_{F(AV)}$ + 0.00433 $I_{F}^{2}_{(RMS)}$

$$P = 0.43 \times I_{F(AV)} + 0.00433 I_{F^{2}(BMS)}$$

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Figure 1. Average forward power dissipation Figure 2. Average forward current versus average forward current ambient temperature ($\delta = 0.5$)



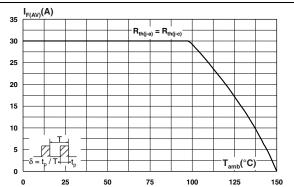
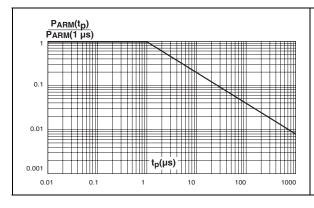


Figure 3. Normalized avalanche power derating versus pulse duration

Figure 4. Normalized avalanche power derating versus junction temperature



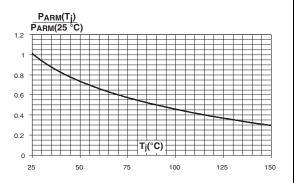
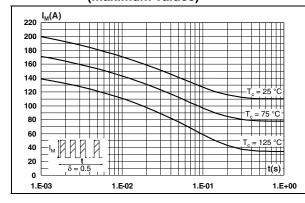
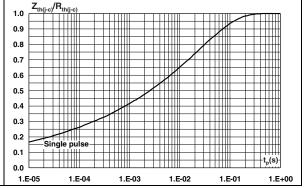


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values)

Figure 6. Relative variation of thermal impedance, junction to case, versus pulse duration

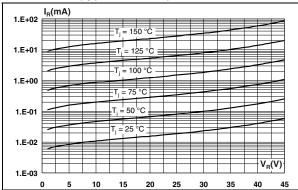




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Figure 7. Reverse leakage current versus reverse voltage applied (typical values)

Figure 8. Junction capacitance versus reverse voltage applied (typical values)



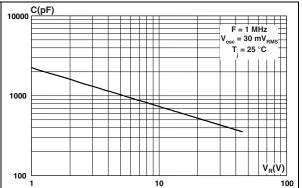
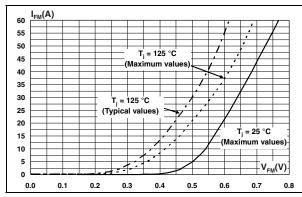
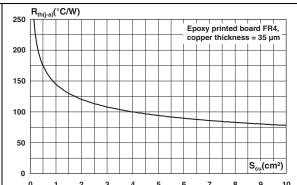


Figure 9. Forward voltage drop versus forward current

Figure 10. Thermal resistance, junction to ambient, versus copper surface under tab





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2 Package information

- Epoxy meets UL94,V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 5. PowerFLAT 5x6 dimensions

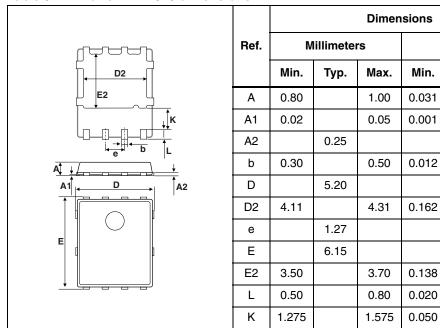
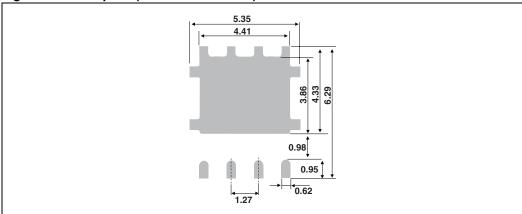


Figure 11. Footprint (dimensions in mm)



Inches

Typ.

0.010

0.205

0.050

0.242

Max.

0.039

0.002

0.020

0.170

0.146

0.031

0.062

Ordering information STPS3045DJF

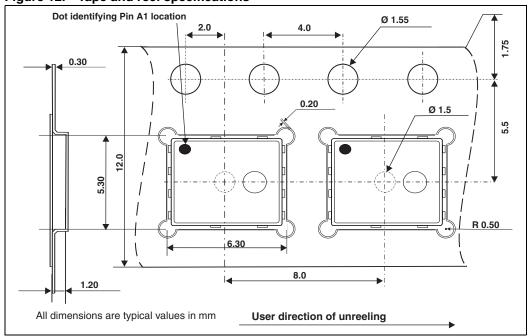


Figure 12. Tape and reel specifications

3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS3045DJF-TR	PS30 45	PowerFLAT 5x6	95 mg	3000	Tape and reel

4 Revision history

Table 7. Document revision history

Date	Revision	Changes
09-Nov-2009	1	First issue.
05-Jul-2010	2	Replace Power QFN with PowerFLAT.
20-May-2011	3	Updated package graphics and marking in <i>Table 6</i> . Added <i>Figure 12</i> .

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